



FEATURES

Operates from 1.65 V to 3.6 V Supply Rails

Unidirectional Signal Path, Bidirectional Level Translation

Tiny 8-Lead SOT-23 Package

Short Circuit Protection

LVTTL/CMOS Compatible Inputs

APPLICATIONS

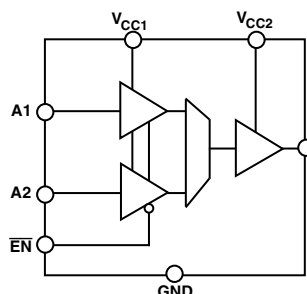
Level Translation

Low Voltage ASIC Translation

Low Voltage Clock Switching

Serial Interface Translation

FUNCTIONAL BLOCK DIAGRAM



GENERAL DESCRIPTION

The ADG3232 is a level translator 2-1 mux designed on a sub-micron process and operates from supplies as low as 1.65 V. The device is guaranteed for operation over the supply range 1.65 V to 3.6 V. It operates from two supply voltages, allowing bidirectional level translation, i.e., it translates low voltages to higher voltages and vice versa. The signal path is unidirectional, meaning data may flow only from A to Y.

This type of device may be used in applications requiring communication between devices operating from different supply levels.

The level translator mux is packaged in one of the smallest footprints available for its pin count. The 8-lead SOT-23 package requires only 8.26 mm × 8.26 mm of board space.

PRODUCT HIGHLIGHTS

1. Bidirectional level translation matches any voltage level from 1.65 V to 3.6 V.
2. The device offers high performance and is fully guaranteed across the supply range.
3. Short circuit protection.
4. Tiny SOT-23 package.

Table I. Truth Table

$\overline{\text{EN}}$	Function
L	A1-Y
H	A2-Y

REV. A

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One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A.
Tel: 781/329-4700 www.analog.com
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ADG3232—SPECIFICATIONS¹ ($V_{CC1} = V_{CC2} = 1.65\text{ V to }3.6\text{ V}$, $\text{GND} = 0\text{ V}$. All specifications T_{MIN} to T_{MAX} , unless otherwise noted.)

Parameter	Symbol	Conditions	Min	Typ ²	Max	Unit
LOGIC INPUTS/OUTPUTS ³						
Input High Voltage ⁴	V _{IH}	V _{CC1} = 3.0 V to 3.6 V	1.35			V
	V _{IH}	V _{CC1} = 2.3 V to 2.7 V	1.35			V
Input Low Voltage ⁴	V _{IH}	V _{CC1} = 1.65 V to 1.95 V	0.65 V _{CC}			V
	V _{IL}	V _{CC1} = 3.0 V to 3.6 V			0.80	V
	V _{IL}	V _{CC1} = 2.3 V to 2.7 V			0.70	V
Output High Voltage	V _{IL}	V _{CC1} = 1.65 V to 1.95 V			0.35 V _{CC}	V
	V _{OH}	I _{OH} = −100 mA, V _{CC2} = 3.0 V to 3.6 V	2.4			V
		V _{CC2} = 2.3 V to 2.7 V	2.0			V
Output Low Voltage	V _{OL}	V _{CC2} = 1.65 V to 1.95 V	V _{CC} − 0.45			V
		I _{OH} = −4 mA, V _{CC2} = 2.3 V to 2.7 V	2.0			V
		V _{CC2} = 1.65 V to 1.95 V	V _{CC} − 0.45			V
		I _{OH} = −8 mA, V _{CC2} = 3.0 V to 3.6 V	2.4			V
		I _{OH} = +100 mA, V _{CC2} = 3.0 V to 3.6 V			0.40	V
		V _{CC2} = 2.3 V to 2.7 V			0.40	V
		V _{CC2} = 1.65 V to 1.95 V			0.45	V
		I _{OH} = +4 mA, V _{CC2} = 2.3 V to 2.7 V			0.40	V
		V _{CC2} = 1.65 V to 1.95 V			0.45	V
		I _{OH} = +8 mA, V _{CC2} = 3.0 V to 3.6 V			0.40	V
SWITCHING CHARACTERISTICS ^{4, 5}						
Propagation Delay, t _{PD}						
A1 to Y	t _{PHL} , t _{PLH}	3.3 V ± 0.3 V, C _L = 30 pF, V _T = V _{CC} /2		4	6.5	ns
A2 to Y	t _{PHL} , t _{PLH}	3.3 V ± 0.3 V, C _L = 30 pF, V _T = V _{CC} /2		3.5	5.4	ns
A1 to Y	t _{PHL} , t _{PLH}	2.5 V ± 0.2 V, C _L = 30 pF, V _T = V _{CC} /2		5	7.2	ns
A2 to Y	t _{PHL} , t _{PLH}	2.5 V ± 0.2 V, C _L = 30 pF, V _T = V _{CC} /2		4.5	6.5	ns
A1 to Y	t _{PHL} , t _{PLH}	1.8 V ± 0.15 V, C _L = 30 pF, V _T = V _{CC} /2		6.5	10.25	ns
A2 to Y	t _{PHL} , t _{PLH}	1.8 V ± 0.15 V, C _L = 30 pF, V _T = V _{CC} /2		6.5	10	ns
ENABLE Time $\overline{\text{EN}}$ to Y	t _{EN}	3.3 V ± 0.3 V, C _L = 30 pF, V _T = V _{CC} /2		4.5	6.5	ns
DISABLE Time $\overline{\text{EN}}$ to Y	t _{DIS}	3.3 V ± 0.3 V, C _L = 30 pF, V _T = V _{CC} /2		4	6.5	ns
ENABLE Time $\overline{\text{EN}}$ to Y	t _{EN}	2.5 V ± 0.2 V, C _L = 30 pF, V _T = V _{CC} /2		5	7.7	ns
DISABLE Time $\overline{\text{EN}}$ to Y	t _{DIS}	2.5 V ± 0.2 V, C _L = 30 pF, V _T = V _{CC} /2		4.8	7.2	ns
ENABLE Time $\overline{\text{EN}}$ to Y	t _{EN}	1.8 V ± 0.15 V, C _L = 30 pF, V _T = V _{CC} /2		7	12	ns
DISABLE Time $\overline{\text{EN}}$ to Y	t _{DIS}	1.8 V ± 0.15 V, C _L = 30 pF, V _T = V _{CC} /2		6.5	10.5	ns
Input Leakage Current	I _I	0 ≤ V _{IN} ≤ 3.6 V			±1	μA
Output Leakage Current	I _O	0 ≤ V _{IN} ≤ 3.6 V			±1	μA
POWER REQUIREMENTS						
Power Supply Voltages	V _{CC1}		1.65		3.6	V
	V _{CC2}		1.65		3.6	V
Quiescent Power Supply Current	I _{CC1}	Digital Inputs = 0 V or V _{CC}			2	μA
	I _{CC2}	Digital Inputs = 0 V or V _{CC}			2	μA
Increase in I _{CC} per Input	ΔI _{CC12}	V _{CC} = 3.6 V, One Input at 3.0 V; Others at V _{CC} or GND			0.75	μA

NOTES

¹ Temperature range is as follows: B Version, -40°C to $+85^\circ\text{C}$.

² All typical values are at $V_{CC1} = V_{CC2}$, $T_A = 25^\circ\text{C}$, unless otherwise stated.

³ V_{IL} and V_{IH} levels are specified with respect to V_{CC1} ; V_{OH} and V_{OL} levels are with respect to V_{CC2} .

⁴ Guaranteed by design, not subject to production test.

⁵ See Test Circuits and Waveforms.

Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS*

(T_A = 25°C, unless otherwise noted.)

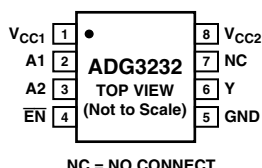
V _{CC} to GND	−0.3 V to +4.6 V
A1, $\overline{\text{EN}}$ Input Voltage	−0.3 V to +4.6 V
A2	−0.3 V to V _{CC1} to +0.3 V
DC Output Current	25 mA
Operating Temperature Range	
Industrial (B Version)	−40°C to +85°C
Storage Temperature Range	−65°C to +150°C
Junction Temperature	150°C

8-Lead SOT-23

θ _{JA} Thermal Impedance	211°C/W
Lead Temperature, Soldering (10 sec)	300°C
IR Reflow, Peak Temperature (<20 sec)	235°C

*Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

PIN CONFIGURATION



CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG3232 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



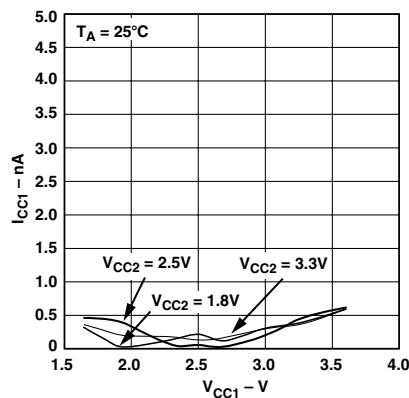
ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option	Branding
ADG3232BRJ-REEL	−40°C to +85°C	SOT-23	RJ-8	W3B
ADG3232BRJ-REEL7	−40°C to +85°C	SOT-23	RJ-8	W3B

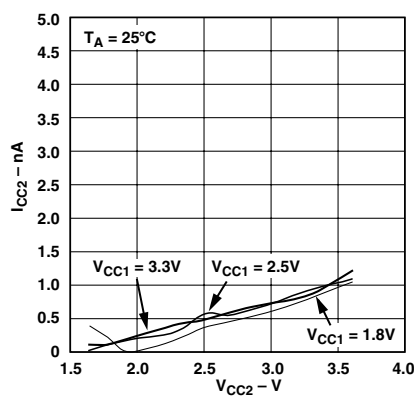
PIN FUNCTION DESCRIPTIONS

Pin No.	Mnemonic	Description
1	V _{CC1}	Supply Voltage 1 can be any supply voltage from 1.65 V to 3.6 V.
2	A1	Input Referred to V _{CC1} .
3	A2	Input Referred to V _{CC1} .
4	$\overline{\text{EN}}$	Active Low Device Enable. When low, bypass mode is enabled; when high, the device is in normal mode.
5	GND	Device Ground Pin.
6	Y	Output Referred to V _{CC2} .
7	NC	Not Internally Connected.
8	V _{CC2}	Supply Voltage 2 can be any supply voltage from 1.65 V to 3.6 V.

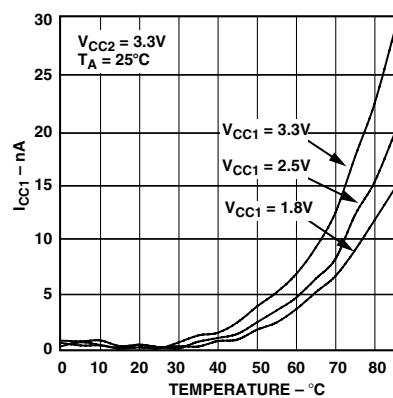
ADG3232–Typical Performance Characteristics



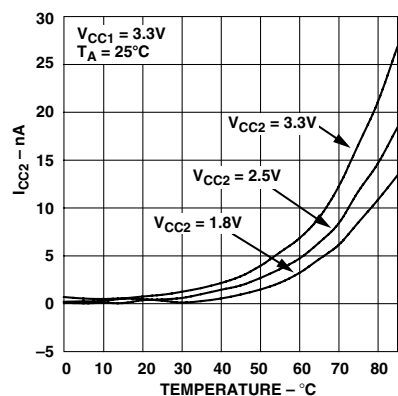
TPC 1. I_{CC1} vs. V_{CC1}



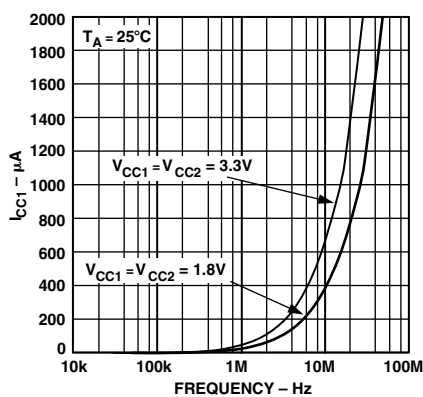
TPC 2. I_{CC2} vs. V_{CC2}



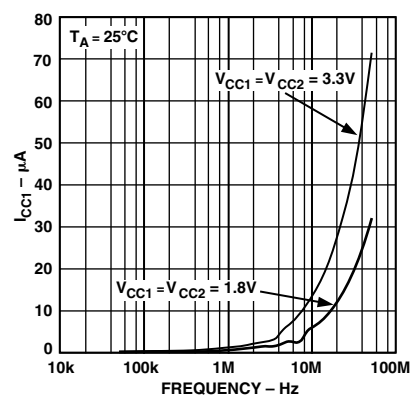
TPC 3. I_{CC1} vs. Temperature



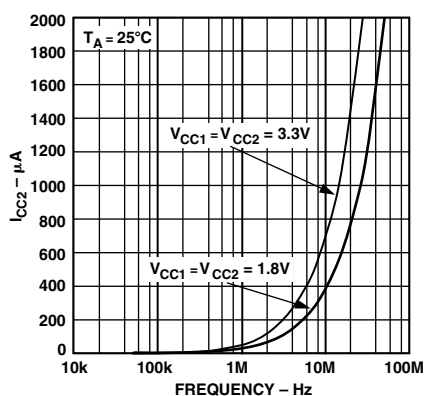
TPC 4. I_{CC2} vs. Temperature



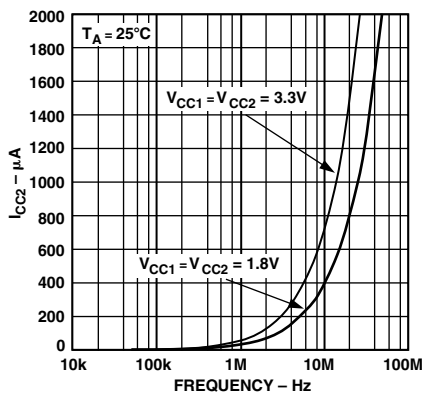
TPC 5. I_{CC1} vs. Frequency, A1–Y



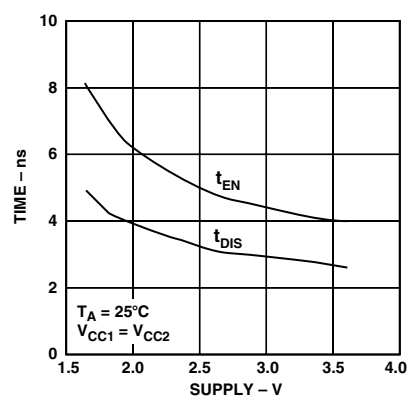
TPC 6. I_{CC1} vs. Frequency, A2–Y



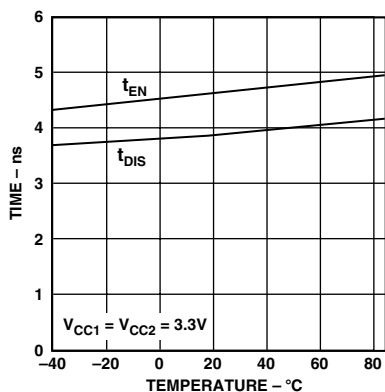
TPC 7. I_{CC2} vs. Frequency, A1–Y



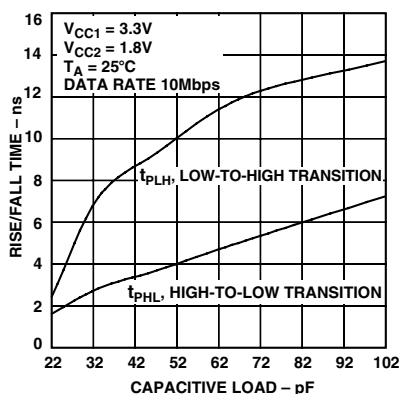
TPC 8. I_{CC2} vs. Frequency, A2–Y



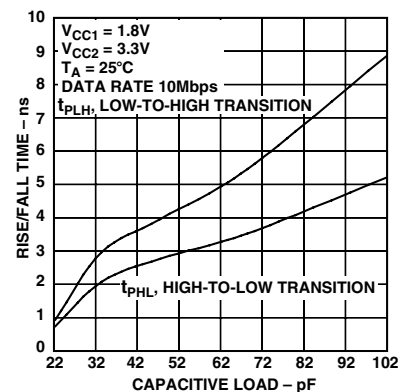
TPC 9. Enable, Disable Time vs. Supply



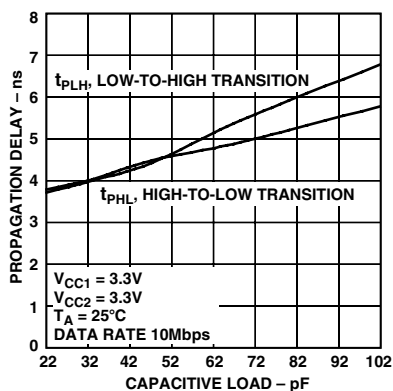
TPC 10. Enable, Disable Time vs. Temperature



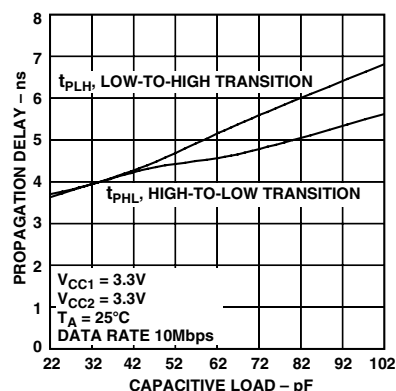
TPC 11. Rise/Fall Time vs. Capacitive Load, A1/A2-Y



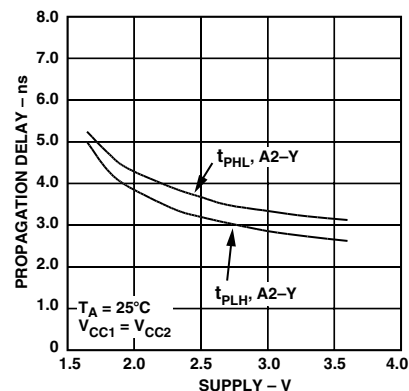
TPC 12. Rise/Fall Time vs. Capacitive Load, A1/A2-Y



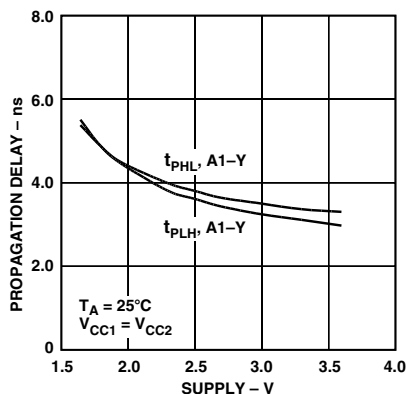
TPC 13. Propagation Delay vs. Capacitive Load, A2-Y



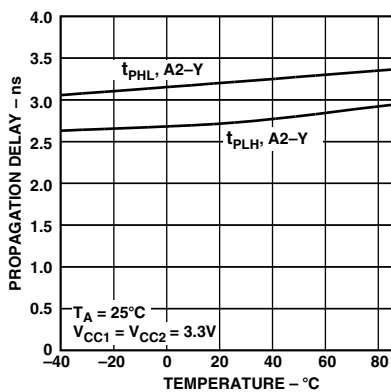
TPC 14. Propagation Delay vs. Capacitive Load, A1-Y



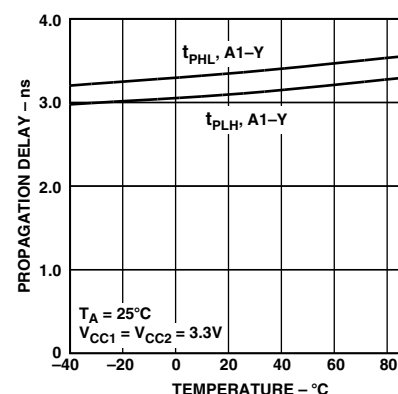
TPC 15. Propagation Delay vs. Supply



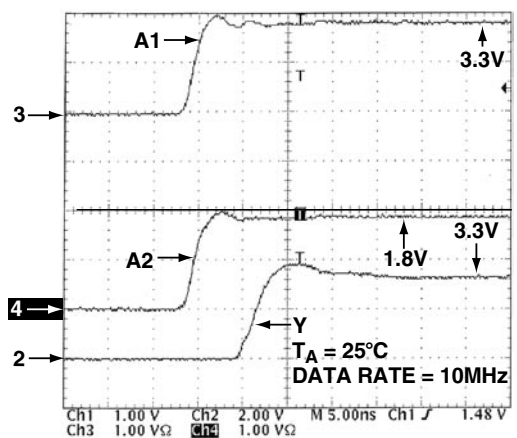
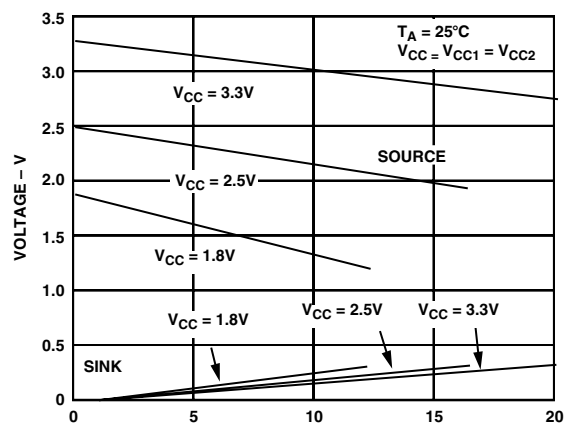
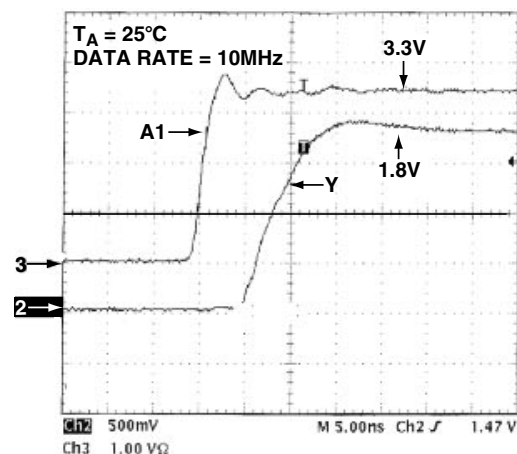
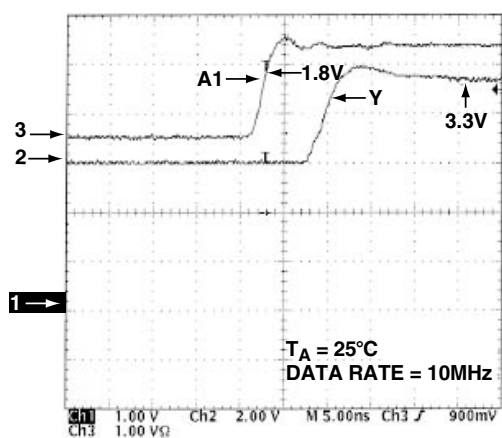
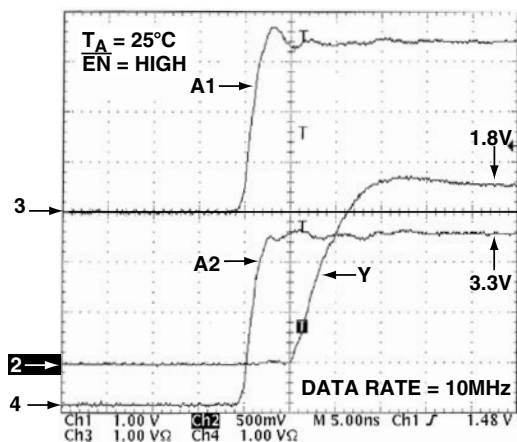
TPC 16. Propagation Delay vs. Supply, A1-Y



TPC 17. Propagation Delay vs. Temperature



TPC 18. Propagation Delay vs. Temperature, A1-Y



TEST CIRCUITS

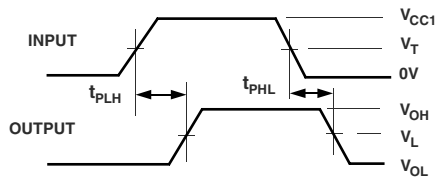


Figure 1. Propagation Delay

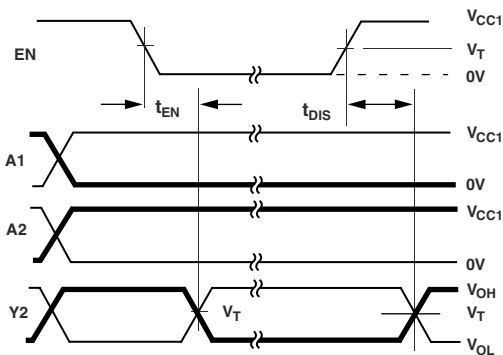


Figure 2. Enable and Disable Times

DESCRIPTION

The ADG3232 is a mux level translating device designed on a submicron process that operates from supplies as low as 1.65 V. The device is guaranteed for operation over the supply range 1.65 V to 3.6 V. It operates from two supply voltages, allowing bidirectional level translation, i.e., it translates lower voltages to higher voltages and vice versa. The signal path is unidirectional, meaning data may only flow from A to Y.

A1 and $\overline{\text{EN}}$ Input

The A1 and enable ($\overline{\text{EN}}$) inputs have V_{IL}/V_{IH} logic levels so that the part can accept logic levels of V_{OL}/V_{OH} independent of the value of the supply being used. Both these inputs (A1 and $\overline{\text{EN}}$) are capable of accepting inputs outside the V_{CC1} supply range. There are no internal diodes to the supply rails on these pins, so they can handle inputs above the supply but inside the absolute maximum ratings.

Operation

Figure 3 shows the ADG3232 in a typical application; the signal paths are from A1 or A2 to Y. The device will level translate the signal applied to A1/A2 from a V_{CC1} logic level (this level translation can be either to a higher or a lower supply) and route the signal to the Y output, which will have standard V_{OL}/V_{OH} levels for V_{CC2} supplies.

The supplies in Figure 3 may be any combination of supplies, e.g., V_{CC1} and V_{CC2} may be anywhere in the 1.65 V to 3.6 V range.

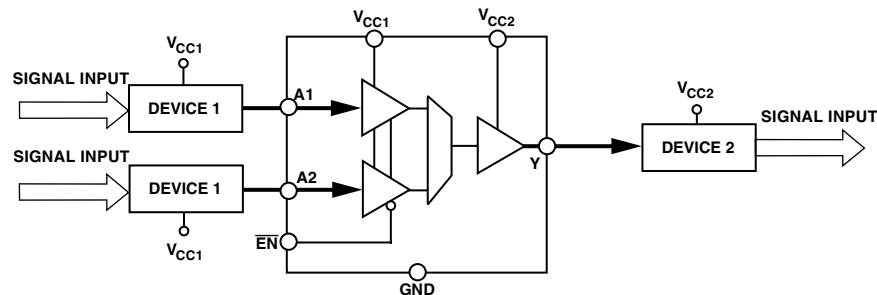
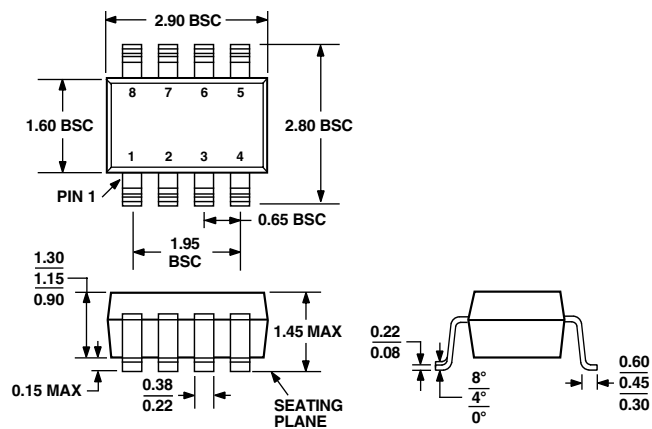


Figure 3. Typical Operation of the ADG3232 Level Translating Switch

OUTLINE DIMENSIONS

8-Lead Small Outline Transistor Package [SOT-23] (RJ-8)

Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MO-178BA

Revision History

Location	Page
7/03—Data Sheet changed from REV. 0 to REV. A.	
Change to PIN FUNCTION DESCRIPTIONS	3

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